

Date issued : August 5, 2020

Bulletin

We, CHI MEI CORPORATION, to the best of our knowledge hereby certify that the resins listed below (hereinafter referred as "products") as directly manufactured by us

POLYLAC® ABS (J01)	PA-704LRP, PA-705, PA-707, PA-757, PA-757 AB, PA-757F, PA-757N, PA-717C, PA-726, PA-726M, PA-727, PA-747, PA-709, PA-797, PA-756, PA-756S, PA-756H, PA-716, PA-746, PA-746H, PA-737, PA-747H, PA-747R, PA-747F, PA-747S, PA-709S, PA-709P, PA-709K, PA-709H, PA-797S, PA-777B, PA-777C, PA-777D, PA-777E, PA-757K, PA-757GJ08, PA-718, PA-746Y, PA-757 A01, PA-747S A01, PA-749, PA-749S, PA-757H, PA-737 A03, PA-77NB, PA-797, PA-746M (J01) - The suffix may be used to denote the black color grade manufactured from Chi Mei Corp. (A01 & A03) - The suffix may be used to denote the white color grade manufactured from Chi Mei Corp.
POLYLAC® MABS	PA-703TRP, PA-758, PA-758R, LS-L230
KIBISAN® SAN	PN-106, PN-107, PN-117, PN-117C, PN-117H, PN-127, PN-127H, PN-137H, PN-106 L150 FG, PN-107 L125 FG, PN-117 L200 FG, PN-127 L150 FG
POLYREX® PS	PG-22, PG-33, PG-80N, PG-80, PG-383, PG-383D, PH-55Y, PH-60, PH-88, PH-888H, PH-888G, PH-88S, PH-88SF
ACRYREX® PMMA	CM-203, CM-205, CM-205G, CM-205N, CM-207, CM-207G, CM-211, CM-211G
ACRYSTEX® SMMA	PM-600, PM-500, PM-500G, PM-700G
KIBITON® TPE	PB-575, PB-585, PB-587, PB-511, PB-5300, PB-5301, PB-5302, PB-5308, PB-5502
KIBITON® Q-resin	PB-5903, PB-5910, PB-5925, PB-5900, PB-5630, PB-5906
KIBIPOL® LBR/SSBR/HBR	PR-245, PR-255, PR-1205, PR-040, PR-040S, PR-040G, PR-040C, PR-050, PR-060S, PR-303
ACRYPOLY®	CM-205X, CM-205B, LM-700X, PM-500X
KIBILITE®	DC-553F, DC-603F, DS-553A, DS-603A, DS-743B, DM-553B, DC-552F, DC-552G, DS-653A, DS-553C, DS-603C, DS-653C, DS-753B, DM-000B, DS-903A, DS-943A, DS-943B, DS-903E, DS-963E, DS-943G, DS-963G, DS-903H, DS-943H, DS-943I, DS-553H, DM-601M, DM-601R, DM-551M, DS-601S, DS-601Y, DS-551A
KIBILAC®	PW-957, PW-978B, PW-997S, PW-997, PW-997G

contain no following substances.

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| 1. Halogen (F, Br, I) and its compounds | 35. Natural Latex |
| 2. Halogen (Cl) | 36. Dioxins and furans |
| 3. PBDEs (Polybrominated Diphenyl Ethers) | 37. Primary aromatic amines (PAA) |
| 4. PBBs (Polybrominated Biphenyls) | 38. Perchlorate |
| 5. Ozone Depleting Chemicals (CFCs & HCFCs) | 39. Hexachlorobenzene |
| 6. Chlorinated Paraffin (C10-C13) | 40. Mirex |
| 7. Polyvinyl Chloride (PVC) | 41. Specified amine compounds |
| 8. Mercury (Hg) and its compounds | 42. Benzene |
| 9. Lead (Pb) and its compounds | 43. Benzenamine, <i>N</i> -phenyl-, Reaction Products with Styrene and 2,4,4-Trimethylpentene (BNST) |
| 10. Cadmium (Cd) and its compounds | 44. Polyamide |
| 11. Chromium (Cr) and its compounds | 45. PVDC (polyvinylidene chloride) |
| 12. Arsenic (As) and its compounds | 46. ESBO (Expoxidized soybean oil) |
| 13. Antimony (Sb) and its compounds | |

The above statement is based on our current level of knowledge and covers the above products directly manufactured and supplied by CHI MEI CORPORATION at the date of issue. CHI MEI CORPORATION makes no warranties, whether express or implied, and assumes no liability in connection with any use of above information. Notwithstanding the foregoing, CHI MEI CORPORATION shall in no event be held obligated or liable for any claims due to or arising from (i) any customer provided, consigned, materials and/or parts, which are incorporated or adopted in the products; (ii) any combination of the products with material not provided or authorized by our company; (iii) any modifications to the products which are made or directed by customer; (iv) our compliance with the specifications, instructions, and/or designs provided by customer; (v) any anti-trust, unfair competition and/or other unlawful actions effected by customer; or (vi) any defects, infringement, breach and/or violation which are arising out of customer's faults or otherwise not solely and directly attributable to CHI MEI CORPORATION. In no event will CHI MEI CORPORATION be liable for any indirect, special, exemplary, punitive, or consequential damages (including lost profits) of any nature whatsoever whether arising out of the purchase, shipment, unloading, handling, or use of any product or otherwise.






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| 14. Selenium (Se) and its compounds | 47. Formamide |
| 15. Barium (Ba) and its compounds | 48. Hexabromocyclododecane (HBCDD) |
| 16. Beryllium (Be) and its compounds | 49. Red phosphorus |
| 17. Bismuth (Bi) and its compounds | 50. Aniline · formaldehyde polycondensate |
| 18. Organic tin compounds (TBT, TPT, DOT, DBT) | 51. Fluorescent powder |
| 19. Polychlorinated Biphenyls (PCBs) and Terphenyls (PCTs) and Naphtalenes (PCNs) | 52. 4,4'-Sulfonyldiphenol (BPS) |
| 20. Poly naphthalenes | 53. Tris(1-chloro-2-propyl)phosphate (TCPP) |
| 21. Azo colorants (according to REACH-ANNEX-XVII-APPENDIX 8) | 54. Tris(1,3-dichloro-2-propyl)phosphate (TDCPP) |
| 22. Asbestos | 55. Tris (2,3-dibromopropyl) phosphate |
| 23. Phthalates | 56. Tris (aziridiny) phosphin oxide |
| 24. APEO: Including Alkylphenol(AP), Octylphenol(OP), Nonylphenol(NP), Octylphenol ethoxylates(OPE), Nonylphenol ethoxylates(NPE) | 57. Tri-o-cresyl phosphate |
| 25. 2-(2'-Hydroxy-3',5'-di-tert-butylphenyl)benzotriazole | 58. Tris (2-chloroethyl) phosphate (TCEP) |
| 26. PFOA and its compounds | 59. Perfluorohexane-1-sulphonic acid and its salts (PFHxS) |
| 27. PFOS and its compounds | 60. Diisononyl phthalate (DINP) |
| 28. Bisphenol A | 61. Di-isodecyl phthalate (DIDP) |
| 29. Formaldehyde | 62. Di-n-octyl phthalate (DnOP) |
| 30. Dimethylfumarate (DMF) | 63. Diethyl phthalate (DEP) |
| 31. Triclosan | 64. Dimethyl phthalate (DMP) |
| 32. Nickel | 65. Cobalt |
| 33. REACH- Candidate List of SVHC | 66. Mica |
| 34. Radioactive Substances | 67. Graphite |
| | 68. Bis (2-ethylhexyl) phthalate (DEHP) |
| | 69. Butyl benzyl phthalate (BBP) |
| | 70. Dibutyl phthalate (DBP) |
| | 71. Diisobutyl phthalate (DIBP) |

With regard to composition of above grades of products, the aforesaid products comply with the Directives of RoHS (EU) 2015/863, 2011/65/EU, 2003/11/EC, TCO'07, Blue Angel and SONY Standard (SS-00259).

Sincerely Yours,


Perry D. B. Shiu

Vice President of R&D Division

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